74ALVCHS162830A **1-BIT TO 2-BIT ADDRESS DRIVER** WITH 3-STATE OUTPUTS SCES624 - FEBRUARY 2005

 Member of the Texas Instruments Widebus™ Family 		PACKAGE P VIEW)
 Output Ports Have Series Damping Resistors, So No External Resistors Are Required 	2Y2 [1 1Y2 [2	80 1Y3 79 2Y3
 Diodes on Inputs Clamp Overshoot 		
	2Y1 4	–
 Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown 		
Resistors	V _{CC} [6 A1 [7	
	AT L 7 A2 [8	
 Latch-Up Performance Exceeds 250 mA Per JESD 17 		
	A3 1 10	6
ESD Protection Exceeds JESD 22	A4 [] 11	6
 2000-V Human-Body Model (A114-A) 200 V Machine Model (A115 A) 		
 200-V Machine Model (A115-A) 	A5 1 13	- H
description/ordering information	A6 🛛 14	
	V _{CC} [15	6
This 1-bit to 2-bit address driver is designed for	A7 🛛 16	6
2.3-V to 3.6-V V _{CC} operation.	A8 🛛 17	
Diodes to V_{CC} have been added on the inputs to	GND [18	63 🛛 GND
clamp overshoot.	<u>A9</u> [19	· •
-	OE1 20	
Active bus-hold circuitry holds unused or undriven	OE2 21	-
inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not	A10 🛛 22	- E
recommended.	GND 23	- F
	A11 🛛 24	
The outputs, which are designed to sink up to	A12 [] 25	H
12 mA, include series damping resistors to reduce		L CC
overshoot and undershoot.	A13 27	· · ·
The ALVCHS162830A is an improved version of	A14 [28 GND 🗍 29	· · · 🔟
the LVCHS162830 (non-A version) and has been		· P
optimized for lower power consumption and	A15 [] 30 A16 [] 31	
higher AC drive. Higher AC drive provides		
capability to drive loads with a faster edge rate.		

To ensure the high-impedance state during power up or power down, the output-enable (\overline{OE}) input should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

50 2Y13 49 GND 48 1Y14 A17 🛛 33 A18 47 2Y14 34 Vcc [46 **V**CC 35 2Y18 [45] 1Y15 36 1Y18 🛛 37 44 2Y15 GND [43 GND 38 2Y17 42 1Y16 39 41 2Y16 1Y17 [40



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description/ordering information

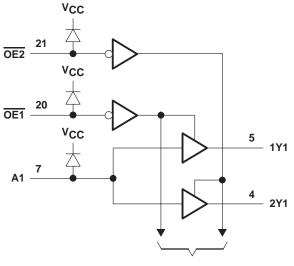
ORDERING INFORMATION

TA	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	TVSOP – DBB	Tape and reel	74ALVCHS162830AGR	ALVCHS162830A

[†]Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

	FUNCTION TABLE									
	INPUTS	OUTI	PUTS							
OE1	OE2	Α	1Yn	2Yn						
L	Н	Н	Н	Z						
L	Н	L	L	Ζ						
н	L	Н	Z	Н						
н	L	L	Z	L						
L	L	Н	н	Н						
L	L	L	L	L						
н	Н	Х	Z	Z						

logic diagram (positive logic)



To 17 Other Channels



74ALVCHS162830A **1-BIT TO 2-BIT ADDRESS DRIVER** WITH 3-STATE OUTPUTS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC} Input voltage range, V_I (see Note 1) Output voltage range, V_O (see Notes 1 and 2) Input clamp current, I_{IK} ($V_I < 0$, $V_I > V_{CC}$) Output clamp current, I_{OK} ($V_O < 0$) Continuous output current, I_O Continuous current through each V_{CC} or GND Package thermal impedance, θ_{JA} (see Note 3) Storage temperature range Temperature	$\begin{array}{cccc} -0.5 \mbox{ V to } V_{CC} + 0.5 \mbox{ V} \\ -0.5 \mbox{ V to } V_{CC} + 0.5 \mbox{ V} \\ \pm 50 \mbox{ mA} \\ -50 \mbox{ mA} \\ \pm 50 \mbox{ mA} \\ -100 \mbox{ mA} \\ -64^{\circ}\mbox{C/W} \end{array}$
Storage temperature range, T _{stg}	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. This value is limited to 4.6 V maximum.

3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 4)

			MIN	MAX	UNIT
VCC	Supply voltage		2.3	3.6	V
		V_{CC} = 2.3 V to 2.7 V	1.7		
VIH	High-level input voltage	$V_{CC} = 2.7 V \text{ to } 3.6 V$	2		V
	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$			0.7	
VIL	Low-level input voltage	$V_{CC} = 2.7 V \text{ to } 3.6 V$		0.8	V
VI	Input voltage		0	VCC	V
VO	Output voltage		0	VCC	V
		V _{CC} = 2.3 V		-6	
IОН	High-level output current	$V_{CC} = 2.7 V$		-8	mA
		$V_{CC} = 3 V$		-12	
		V _{CC} = 2.3 V		6	
IOL	Low-level output current	$V_{CC} = 2.7 V$		8	mA
		$V_{CC} = 3 V$		12	
$\Delta t/\Delta v$	Input transition rise or fall rate			10	ns/V
TA	Operating free-air temperature		-40	85	°C

NOTE 4: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



74ALVCHS162830A **1-BIT TO 2-BIT ADDRESS DRIVER** WITH 3-STATE OUTPUTS

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electrical characteristics	over	recommended	operating	free-air	temperature	range	(unless
otherwise noted)					-	•	

PARA	METER	TEST C	ONDITIONS	V _{CC}	MIN	TYP [†]	MAX	UNIT
		l _l = –18 mA		2.3 V			-1.2	.,
VIK		lj = 18 mA		2.3 V		VC	C + 1.2	V
		I _{OH} = -100 μA		2.3 V to 3.6 V	V _{CC} – 0	0.2		
		$I_{OH} = -4 \text{ mA},$	V _{IH} = 1.7 V	2.3 V	1.9			
			V _{IH} = 1.7 V	2.3 V	1.7			.,
VOH		I _{OH} = -6 mA	V _{IH} = 2 V	3 V	2.4			V
		I _{OH} = -8 mA,	V _{IH} = 2 V	2.7 V	2			
		I _{OH} = -12 mA,	V _{IH} = 2 V	3 V	2			
		I _{OL} = 100 μA		2.3 V to 3.6 V			0.2	
		I _{OL} = 4 mA,	V _{IL} = 0.7 V	2.3 V			0.4	
.,			VIL = 0.7 V	2.3 V			0.55	
VOL	V _{OL}	I _{OL} = 6 mA	V _{IL} = 0.8 V	3 V			0.55	V
		I _{OL} = 8 mA,	V _{IL} = 0.8 V	2.7 V			0.6	
		I _{OL} = 12 mA,	V _{IL} = 0.8 V	3 V			0.8	
lj		V _I = V _{CC} or GND		3.6 V			±5	μA
		V _I = 0.7 V		2.3 V	45			
		V _I = 1.7 V		2.3 V	-45			
ll(hold)		V _I = 0.8 V		3 V	75			μA
.()		V _I = 2 V		3 V	-75			·
		$V_{I} = 0$ to 3.6 V [‡]		3.6 V			±500	
I _{OZ}		$V_{O} = V_{CC}$ or GND		3.6 V			±10	μA
ICC		$V_{I} = V_{CC}$ or GND,	I _O = 0	3.6 V			20	μA
∆ICC			Other inputs at V _{CC} or GND	3 V to 3.6 V			500	μA
	Control inputs		•••	1		3.5		_
Ci	Data inputs	$V_{I} = V_{CC} \text{ or } GND$		3.3 V		4.5		pF
C _o	Outputs	$V_{O} = V_{CC}$ or GND		3.3 V		4.5		pF

[†] All typical values are at V_{CC} = 3.3 V, T_A = 25°C. [‡] This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	TO	(OUTPUT) ± 0.2 V		V _{CC} =	2.7 V	۲ <mark>0.5 v_{CC} =</mark>	3.3 V 3 V	UNIT
	(INPUT)	(001P01)	MIN	MAX	MIN	MAX	MIN	MAX	
^t pd	А	Y	1.2	3.8		4	1.7	3.5	ns
t _{en}	OE	Y	1	5.7		5.7	1	4.8	ns
^t dis	OE	Y	1	4.9		5.4	1.7	5.2	ns

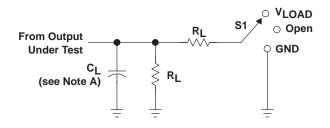
operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER		TEST C	ONDITIONS	V _{CC} = 2.5 V TYP	V _{CC} = 3.3 V TYP	UNIT
	Power dissipation capacitance One OE enabled		0.0	£ 10 MU	17	17.5	pF
Cpd	per bit (one output switching)	$C_{\rm I} = 0$ f = 10 MHz			0.4	0.5	рг



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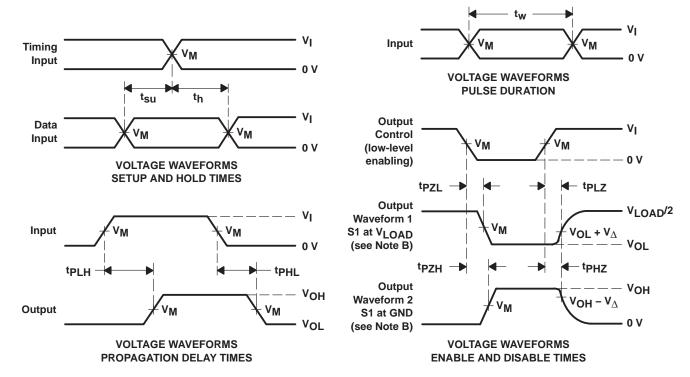
PARAMETER MEASUREMENT INFORMATION

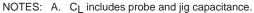


LOAD CIRCUIT

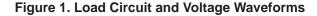
TEST	S1
^t pd	Open
^t PLZ ^{/t} PZL	V _{LOAD}
^t PHZ ^{/t} PZH	GND

Mara	IN	PUT	Mar	Manage	0	D	V
VCC	VI t _r /t _f		Vм	VLOAD	СL	RL	v_Δ
2.5 V \pm 0.2 V	Vcc	≤2 ns	V _{CC} /2	$2 \times V_{CC}$	30 pF	500 Ω	0.15 V
2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
3.3 V \pm 0.3 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V





- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_O = 50 Ω.
- An input purses are supplied by generations having the following characteristics. $FKK \ge 10$ MHz, $Z_0 = 0$
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. tPLH and tPHL are the same as tpd.
- H. All parameters and waveforms are not applicable to all devices.





PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins I	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
74ALVCHS162830AGR	ACTIVE	TSSOP	DBB	80	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
ALVCHS162830AGRE4	ACTIVE	TSSOP	DBB	80	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
ALVCHS162830AGRG4	ACTIVE	TSSOP	DBB	80	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD**: The Pb-Free/Green conversion plan has not been defined.

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⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
74ALVCHS162830AGR	TSSOP	DBB	80	2000	330.0	24.4	8.4	17.3	1.7	12.0	24.0	Q1



PACKAGE MATERIALS INFORMATION

11-Mar-2008



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
74ALVCHS162830AGR	TSSOP	DBB	80	2000	346.0	346.0	41.0

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